Disc-Type EMIFIL® (A miniature three-terminal capacitor)
DSS6N□□□□□□□□□□ Reference Specification

1.Scope

This reference specification applies to DSS6N series.

2.Part Numbering

(Ex.) DS ① S ② 6 ③ N ④ C5 ⑤ 2A ⑥ 271 ⑦ Q93 ⑧ A ⑨

①Product ID (Disc-Type EMIFIL®)
②Structure S : Built-in Ferrite Beads Type
③Style
④Features
⑤Temperature Characteristics
⑥Rated Voltage
⑦Capacitance Marked three digits system.(Ex. 270pF→271)
⑧Lead Type

Q5□/ T□1 : Bulk (in mm)

	Long Lead Type	Short Lead Type	
Straight Lead Type	**Q55**	**Q56**	**Q54**
Incrimp Lead Type	**T51**	—	**T41**
Lead Length(l)	25.0 min.	6.0±1.0	4.0±0.5

Lead Length (l) : See item 10.

Q9□/ U□1 : Taping (in mm)

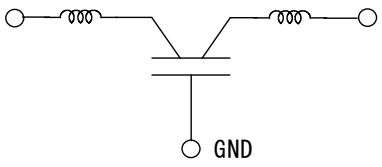
Straight Lead Type	**Q91**	**Q92**	**Q93**
Incrimp Lead Type	—	**U21**	**U31**
Dimension H	20.0±1.0	16.5±1.0	18.5±1.0

Dimension H : See item 10.

⑨Packaging Code A : Ammo Pack / B : Bulk

3.Rating

Operating temperature : -25 to +85°C
Storage Temperature : -25 to +85°C
Insulation Resistance : 5000MΩ min.
Rated Current : 6A(DC)
Equivalent Circuit :



Unit Mass (Typical value) : 0.45g
Others : See Table 1

Table 1

Customer Part Number	Murata Part Number	Temperature Characteristics	Capacitance	Rated Voltage	Withstanding Voltage
	DSS6NC52A220Q55B	±22%	22pF± 20%	100V(DC)	250 V(DC)
	DSS6NC52A220Q56B				
	DSS6NC52A220Q54B				
	DSS6NC52A220T51B				
	DSS6NC52A220T41B				
	DSS6NC52A220Q91A				
	DSS6NC52A220Q92A				
	DSS6NC52A220Q93A				
	DSS6NC52A220U21A				
	DSS6NC52A220U31A				

Customer Part Number	Murata Part Number	Temperature Characteristics	Capacitance	Rated Voltage	Withstanding Voltage
	DSS6NC52A330Q55B	±22%	33pF± 20%	100V(DC)	250 V(DC)
	DSS6NC52A330Q56B				
	DSS6NC52A330Q54B				
	DSS6NC52A330T51B				
	DSS6NC52A330T41B				
	DSS6NC52A330Q91A				
	DSS6NC52A330Q92A				
	DSS6NC52A330Q93A				
	DSS6NC52A330U21A				
	DSS6NC52A330U31A				
	DSS6NC52A470Q55B		47pF± 20%		
	DSS6NC52A470Q56B				
	DSS6NC52A470Q54B				
	DSS6NC52A470T51B				
	DSS6NC52A470T41B				
	DSS6NC52A470Q91A				
	DSS6NC52A470Q92A				
	DSS6NC52A470Q93A				
	DSS6NC52A470U21A				
	DSS6NC52A470U31A				
	DSS6NC52A101Q55B		100pF± 20%		
	DSS6NC52A101Q56B				
	DSS6NC52A101Q54B				
	DSS6NC52A101T51B				
	DSS6NC52A101T41B				
	DSS6NC52A101Q91A				
	DSS6NC52A101Q92A				
	DSS6NC52A101Q93A				
	DSS6NC52A101U21A				
	DSS6NC52A101U31A				
	DSS6NC52A151Q55B		150pF± 20%		
	DSS6NC52A151Q56B				
	DSS6NC52A151Q54B				
	DSS6NC52A151T51B				
	DSS6NC52A151T41B				
	DSS6NC52A151Q91A				
	DSS6NC52A151Q92A				
	DSS6NC52A151Q93A				
	DSS6NC52A151U21A				
	DSS6NC52A151U31A				
	DSS6NC52A221Q55B		220pF± 20%		
	DSS6NC52A221Q56B				
	DSS6NC52A221Q54B				
	DSS6NC52A221T51B				
	DSS6NC52A221T41B				
	DSS6NC52A221Q91A				
	DSS6NC52A221Q92A				
	DSS6NC52A221Q93A				
	DSS6NC52A221U21A				
	DSS6NC52A221U31A				

Customer Part Number	Murata Part Number	Temperature Characteristics	Capacitance	Rated Voltage	Withstanding Voltage
	DSS6NC52A271Q55B	±22%	270pF± 20%	100V(DC)	250 V(DC)
	DSS6NC52A271Q56B				
	DSS6NC52A271Q54B				
	DSS6NC52A271T51B				
	DSS6NC52A271T41B				
	DSS6NC52A271Q91A				
	DSS6NC52A271Q92A				
	DSS6NC52A271Q93A				
	DSS6NC52A271U21A				
	DSS6NC52A271U31A				
	DSS6NC52A471Q55B		470pF± 20%		
	DSS6NC52A471Q56B				
	DSS6NC52A471Q54B				
	DSS6NC52A471T51B				
	DSS6NC52A471T41B				
	DSS6NC52A471Q91A				
	DSS6NC52A471Q92A				
	DSS6NC52A471Q93A				
	DSS6NC52A471U21A				
	DSS6NC52A471U31A				
	DSS6NC52A102Q55B		1000pF± 20%		
	DSS6NC52A102Q56B				
	DSS6NC52A102Q54B				
	DSS6NC52A102T51B				
	DSS6NC52A102T41B				
	DSS6NC52A102Q91A				
	DSS6NC52A102Q92A				
	DSS6NC52A102Q93A				
	DSS6NC52A102U21A				
	DSS6NC52A102U31A				
	DSS6NE52A222Q55B	$\pm^{22}_{56}$ %	2200pF± $^{80}_{20}$%		
	DSS6NE52A222Q56B				
	DSS6NE52A222Q54B				
	DSS6NE52A222T51B				
	DSS6NE52A222T41B				
	DSS6NE52A222Q91A				
	DSS6NE52A222Q92A				
	DSS6NE52A222Q93A				
	DSS6NE52A222U21A				
	DSS6NE52A222U31A				

4.Testing Conditions

<Unless otherwise specified>
Temperature : Ordinary Temperature 15 to 35°C
Humidity : Ordinary Humidity 25 to 85 %(RH)

<In case of doubt>
Temperature : 20 ± 2°C
Humidity : 60 to 70 %(RH)
Atmospheric Pressure : 86 to 106 kPa

5.Style and Dimension

See item 9.

6.Marking

Capacitance	Marked real number. (22pF to 47pF) Ex. 22pF→22 Marked three digits system.(100pF to 22000pF) Ex.1000pF→102
Rated Voltage	Marked voltage value.(100V)
Trade Mark	Marked as Ⓜ

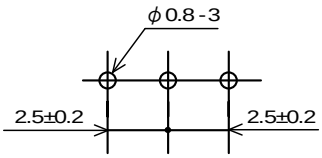
7.Performance

<table>
<tr><th>No.</th><th>Item</th><th>Specification</th><th>Test Method</th></tr>
<tr><td>7.1</td><td>Appearance and Dimensions</td><td>Meet item 9.</td><td>Visual Inspection and measured with Slide Calipers.</td></tr>
<tr><td>7.2</td><td>Marking</td><td>Marking is able to be read easily.</td><td>Visual Inspection.</td></tr>
<tr><td>7.3</td><td>Capacitance and Tolerance</td><td>Meet item 3.</td><td>Table 2
<table><tr><th>Frequency</th><th>Test Voltage</th><th>Capacitance</th></tr><tr><td>1±0.1MHz</td><td>3 V(rms) max.</td><td>22pF～100pF</td></tr><tr><td>1±0.1kHz</td><td>3 V(rms) max.</td><td>150pF～2200pF</td></tr></table></td></tr>
<tr><td>7.4</td><td>Insulation Resistance(I.R.)</td><td>Meet item 3.</td><td>Test Voltage : Rated Voltage
Time : 1 minute through a suitable resistor 1MΩ.</td></tr>
<tr><td>7.5</td><td>Withstanding Voltage</td><td>Products shall not be damaged.</td><td>Test Voltage : 2.5 times for Rated Voltage
Time : 1 to 5 seconds
Charge Current : 10 mA max.
It shall be applied between input / output terminal and ground terminal.</td></tr>
<tr><td>7.6</td><td>Temperature Characteristics</td><td>Meet item 3.</td><td>Capacitance shall be measured at each step specified in Table 3 after reaching the thermal equilibrium.
The capacitance change against the capacitance at step 3 shall be calculated.
Table3
<table><tr><th>Step</th><th>1</th><th>2</th><th>3</th><th>4</th><th>5</th></tr><tr><td>Temp. (°C)</td><td>+25±2</td><td>-25±2</td><td>+25±2</td><td>+85±2</td><td>+25±2</td></tr></table></td></tr>
<tr><td>7.7</td><td>Solderability</td><td>Along the circumference of terminal shall be covered with new solder at least 75%.</td><td>Flux : Ethanol solution of rosin,25(wt)%
(dipped for 5 to 10 seconds)
Pre-heat : 150±10℃, 60～90 s
Solder : Sn-3.0Ag-0.5Cu
Solder Temperature : 245±5℃
Immersion Time : 2 ± 0.5 seconds
Immersion Depth :
2 to 2.5 mm from the bottom of the body.</td></tr>
<tr><td>7.8</td><td>Resistance to Soldering Heat</td><td>Meet Table 4.
Table 4
<table><tr><td>Appearance</td><td colspan="2">No damaged.</td></tr><tr><td rowspan="2">Capacitance Change</td><td>C5</td><td>within ± 5%</td></tr><tr><td>E5</td><td>within ± 20%</td></tr><tr><td>Withstanding Voltage</td><td colspan="2">No damaged.</td></tr></table></td><td>Flux : Ethanol solution of rosin,25(wt)%
(dipped for 5 to 10 seconds)
Pre-heat : 150±10℃, 60～90 s
Solder : Sn-3.0Ag-0.5Cu
Solder Temperature : 270± 5°C
Immersion Time : 3± 0.5 seconds
Immersion Depth :
1.6 ± 0.8 mm from the bottom of the body.
Then measured after exposure in the room condition for 4 to 24hours.</td></tr>
<tr><td>7.9</td><td>Humidity</td><td>Meet Table 5.
Table 5
<table><tr><td>Appearance</td><td colspan="2">No damaged.</td></tr><tr><td rowspan="2">Capacitance Change</td><td>C5</td><td>within ± 10%</td></tr><tr><td>E5</td><td>within ± 20%</td></tr><tr><td>Insulation Resistance</td><td colspan="2">1000MΩ min.</td></tr></table></td><td>Temperature : 40 ± 2°C
Humidity : 90 to 95 %(RH)
Time : 500 hours(+24-0 hours)
Then measured after exposure in the room condition for 4 to 24hours.</td></tr>
</table>

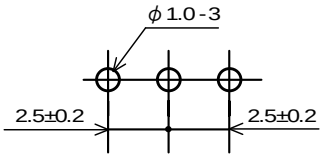
No.	Item	Specification	Test Method
7.10	Humidity Life	Meet Table6. Table 6 Appearance: No damaged. Capacitance Change: C5 within ± 10%; E5 within ± 20% Insulation Resistance: 500MΩ min.	Temperature : 40 ± 2°C Humidity : 90 to 95 %(RH) Time : 500 hours(+24-0 hours) Applying Voltage : Rated Voltage Charge Current : 10 mA max. Then measured after exposure in the room condition for 4 to 24hours.
7.11	Heat Life	Meet Table 5.	Temperature : 85 ± 3°C Time : 1000 hours(+48-0 hours) Applying Voltage : 2 times of DC rated voltage Charge Current : 10 mA max. Then measured after exposure in the room condition for 4 to 24hours.

8.Mounting Hole

Bulk



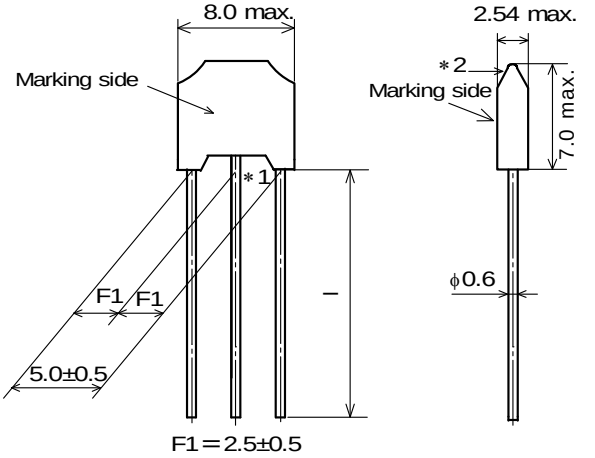
Taping



in mm

9.Style and Dimension

(1) Bulk(Straight Lead Type) : Q5☐

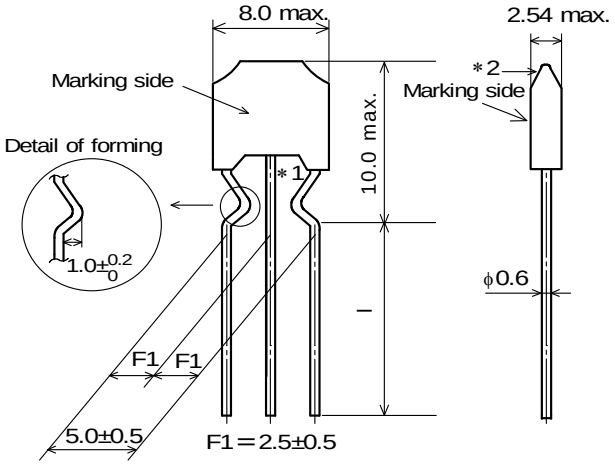


*1.Bottom of dielectric may be exposed.
*2.There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

Lead Type	l
Q55	25.0 min.
Q56	6.0±1.0
Q54	4.0±0.5

(in mm)

(2) Bulk (Incrimp Lead Type) : T☐1



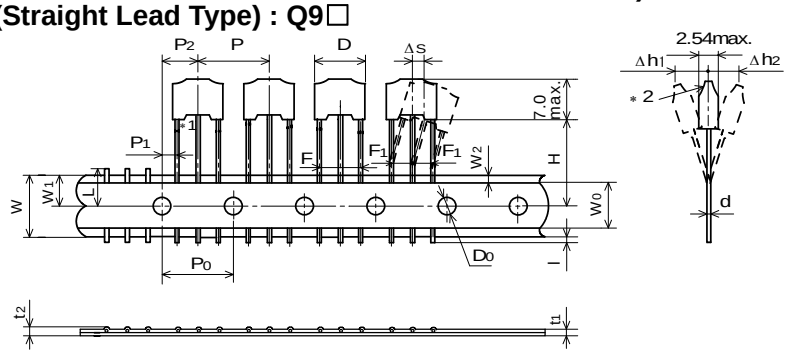
*1.Bottom of dielectric may be exposed.
*2.There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

Lead Type	l
T51	25.0 min.
T41	4.0±0.5

(in mm)

(All symbols in the illustrations below are described in Table 7)

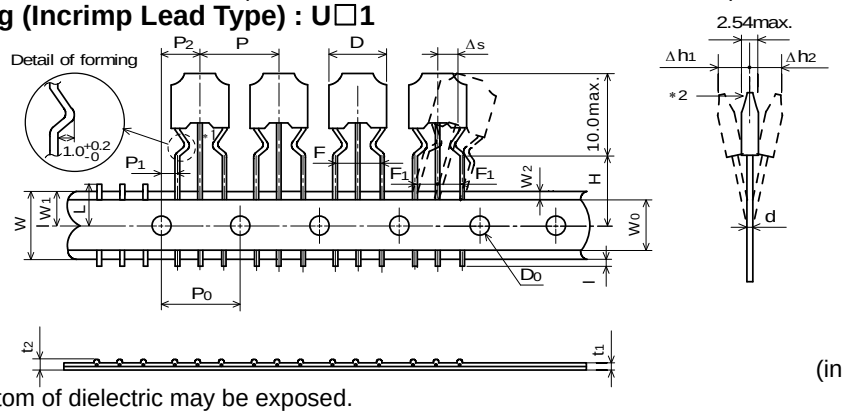
(3) Taping(Straight Lead Type) : Q9□



＊1.Bottom of dielectric may be exposed.

＊2.There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

(4) Taping (Incrimp Lead Type) : U□1



(in mm)

＊1.Bottom of dielectric may be exposed.

＊2.There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

Table 7

Code	Description	Dimensions		Remark
P	Pitch of Component	12.7		Product Inclination ΔS Determines Crossing
P_0	Pitch of Sprocket Hole	12.7±0.2		
P_1	Length from Hole Center to Lead	3.85±0.7		
P_2	Length from Hole Center to Component Center	6.35±1.3		Shift In Tape In Direction of Feed
D	Width of Body	8.0 max.		
ΔS	Deviation along tape,Left or Right	0±1.0		
W	Carrier Tape Width	18.0±0.5		
W_1	Position of Sprocket Hole	9.0+0,-0.5		Tape Widthwise Shift
l	Protrusion Length	+0.5 ~ -1.0		
D_0	Diameter of Sprocket Hole	ϕ 4.0±0.1		
d	Lead Diameter	ϕ 0.6		
t_1	Total Tape Thickness	0.7±0.2		Includes Thickness of Bonding Tape
t_2	Total Thickness,Tape and Lead Wire	1.5 max.		
Δh_1	Deviation across Tape,front	1.0 max.		
Δh_2	Deviation across Tape,rear	1.0 max.		
L	Portion to Cut in Case of Defect	11.0+0,-1.0		
W_0	Hold Down Tape Width	12.0±0.5		
W_2	Hold Down Tape Position	1.5±1.5		
H	Lead length between sprocket hole and forming position	**Q91**	20.0±1.0	
		Q92 U21	16.5±1.0	
		Q93 U31	18.5±1.0	
F	Lead Spacing	5.0+0.8,-0.2		
F_1		2.5+0.4,-0.2		

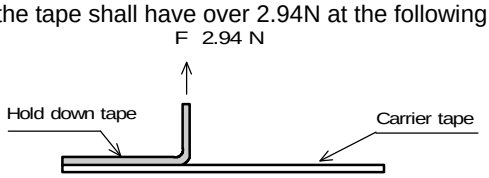
(in mm)

10.Taping

10.1 Supplement condition of taping

(1) A maximum of 0.3% of the components quantity per reel or ammo pack may be missing without consecutive missing components.

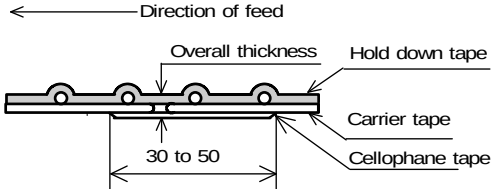
(2) The adhesive power of the tape shall have over 2.94N at the following condition.



(3) Splicing method of tape

1. Carrier tape

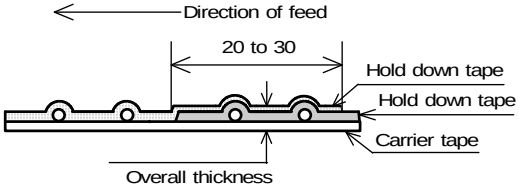
Carrier tape shall be spliced by cellophane tape.
Overall thickness shall be less than 1.05 mm.



(in mm)

2. Hold down tape

Hold down tape shall be spliced with overlapping.
Overall thickness shall be less than 1.05 mm.



(in mm)

3. Both carrier tape and hold down tape

Both tapes shall be cut zigzag and spliced with splicing tape.

11. Packing

11.1 Packing quantity

The standard packing quantity is as follows.
(The packing quantity may be changed due to a fraction of order.)

Minimum Packing Form and Quantity

Terminal Configuration		A Unit Quantity Bulk : in a plastic bag Taping : in an ammo pack	* Standard Quantity in a container (corrugated cardboard box)
Bulk	Long Lead Type (Q55/T51)	250 pcs.	5000 pcs.
	Short Lead Type (Q54/Q56/T41)	500 pcs.	10000 pcs.
Taping (Q91/ Q92/ Q93/U21/U31)		2000 pcs.	20000 pcs.

* A quantity in a container is depending on a quantity of an order.

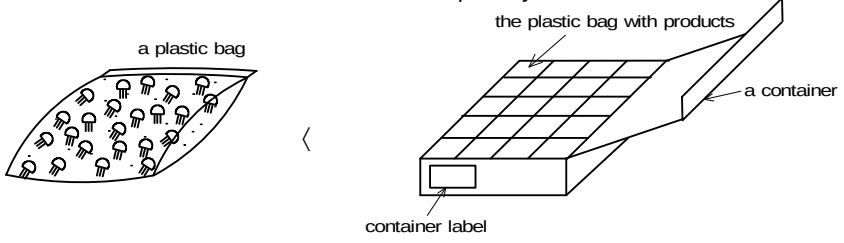
11.2 Packing Form

(1) Bulk

<A plastic bag pack>

1.Products are packed into a plastic bag.

2.The plastic bags are put into a container (corrugated cardboard box) depending on a quantity of an order.



(2) Taping

<An Ammo pack>

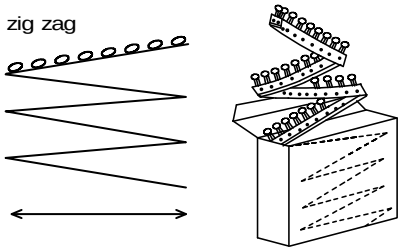
1 .Folding the tape per 25 pitches,products are packed into an package so that each product of each layer wound zigzag is put on top of one another. [Fig 1]

2. The dimensions of the package are indicated in [Fig 2].

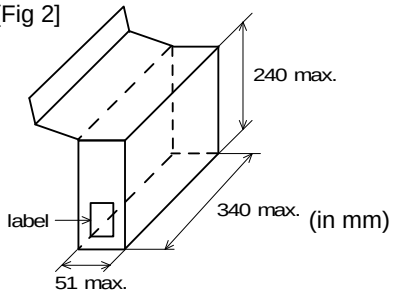
3. The ammo packages are put into a container (corrugated cardboard box) depending on a quantity of an order.

4. Not less than 3 consecutive of component shall be missing on both edge of tape.

[Fig 1]



[Fig 2]



The unloading direction : Right
The hold down tape : Upper
The product body : Left along the unloading direction

12.Marking on package

12.1 Unit Package

Bulk : Marked on a plastic bag.
Taping : Marked on a label stuck on an ammo package.

Marking on a unit package consists of :
Customer part number**,** MURATA part number, Inspection number(∗1), RoHS marking (∗2), Quantity, etc

∗1) « Expression of Inspection No. » $\underset{(1)}{\square\square}$ $\underset{(2)}{OOOO}$ $\underset{(3)}{\times\times\times}$

(1) Factory Code
(2) Date First digit : Year / Last digit of year
Second digit : Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O,N,D
Third, Fourth digit : Day
(3) Serial No.

∗2) « Expression of RoHS marking » ROHS – $\underset{(1)}{Y}$ ($\underset{(2)}{\triangle}$)

(1) RoHS regulation conformity parts.
(2) MURATA classification number

12.2 Container

Marking on the label sticked on a container consists of :
Customer name Purchasing Order Number, Customer Part Number, MURATA part number,
RoHS marking (∗2), Quantity, etc

13. ⚠ Caution

13.1Mounting holes

Mounting holes should be designed as specified in this specifications.
Or different design from this specifications may cause cracks in ceramics which may lead to smoking / firing.

13.2 Caution for the product angle adjust work

Take care not to apply any mechanical stress to product body at the lead terminal bending process for product angle adjustment after insertion.

13.3 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

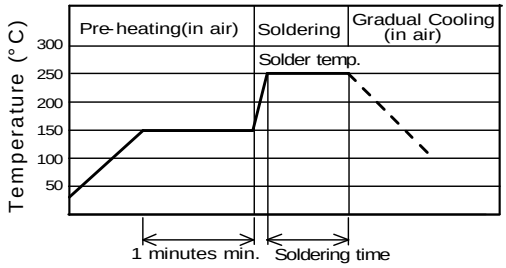
(1) Aircraft equipment
(2) Aerospace equipment
(3) Undersea equipment
(4) Power plant control equipment
(5) Medical equipment
(6) Transportation equipment (vehicles, trains, ships, etc.)
(7) Traffic signal equipment
(8) Disaster prevention / crime prevention equipment
(9) Data-processing equipment
(10) Applications of similar complexity and /or reliability requirements to the applications listed in the above

14. Notice

14.1 Soldering

(1) Use rosin-based flux. Do not use strong acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).
Use Sn-3.0Ag-0.5Cu solder

(2) Standard flow soldering profile.



Solder temperature	Soldering time
250～260 °C	4～6s

(3) Resistance to soldering iron goes in the following condition that tip temperature is 350 °C max. and soldering time is 5 s max.
(4) Products and the leads should not be subjected to any mechanical stress during soldering process. (and also while subjected to the equivalent high temperature.)

14.2 Cleaning

Products shall be cleaned on following conditions.
(1) Cleaning Temperature: 60℃ max.(40℃ max. for Isopropyl alcohol).
(2) Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.
Power : 20W / l max.
Frequency : 28kHz ~ 40kHz
Time : 5 minutes max.
(3) Cleaning agent
1. alcohol cleaning agents.
・Isopropyl alcohol (IPA)
2. Aqueous cleaning agent
・Pine Alpha ST-100S
(4) Ensure that residual flux and residual cleaning agent is completely removed.
Products should be thoroughly dried after aqueous agent has been removed with de-ionized water.
(5) For other cleaning methods, please contact Murata engineering.

14.3 Operating Environment

(1) Do not use products in corrosive gases such as chlorine gas, acid or sulfide gas.
(2) Do not use products in the environment where water, oil or organic solvents may adhere to products.
(3) Do not adhere any resin to products, coat nor mold products with any resin (including adhesive)to prevent mechanical and chemical stress on products.

14.4 Storage and handling requirements.

(1) Storage period
Use the products within 12 months after delivered.
Solderability should be checked if this period is exceeded.
(2) Storage environment condition
To prevent products quality deterioration, storage conditions should be controlled as follows ;
1. Temperature : -10 to 40 degrees centigrade
2. Humidity : 15% to 85% relative humidity
3. Products should be stored without sudden changes in temperature and humidity.
Don't keep products in corrosive gases such as sulfur,chlorine gas or acid,
or it may cause oxidization of lead terminals resulting in poor solderability.
4. Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
5. Products should be stored in the warehouse without heat shock, vibration,direct sunlight and so on.
(3) Handling Conditions
Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

15. ⚠ Note

(1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

(2)You are requested not to use our product deviating from the reference specifications.

(3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.